FEATURES
- ±2% Accurate Average Input Current Limit
- Programmable Up to 3A
- Programmable Maximum Capacitor Voltage Limit
- Active Charge Balancing for Fast Charging of Unmatched Capacitors
- Charges Single or Stacked Capacitors
- VIN Range: 1.73V to 5.5V
- VOUT Range: 1.8V to 5.5V
- <2μA Quiescent Current from VOUT When Charged
- Output Disconnect in Shutdown: <1μA IQ Shutdown
- Power-Good Comparator
- Power Failure Indicator
- Thermally Enhanced 20-Lead (4mm × 5mm × 0.75mm) QFN and 24-Lead TSSOP Packages

APPLICATIONS
- Supercapacitor Based Backup Power
- Memory Backup
- Servers, RAID, RF Systems
- Industrial, Communications, Computing

DESCRIPTION
The LTC®3128 is a highly efficient, buck-boost DC/DC supercapacitor charger. It operates efficiently from input voltages above, below or equal to the output voltage. The LTC3128 incorporates accurate programmable average input current limit, active charge balancing and programmable maximum capacitor voltage. This combination of features makes the LTC3128 ideal for safely charging and protecting large capacitors in backup power systems. The input current limit and maximum capacitor voltage are each programmed using a single resistor. Average input current is accurately controlled over a 0.5A to 3A programmable range while the individual maximum capacitor voltage can be set from 1.8V to 3.0V.

Other features of the LTC3128 include <2μA quiescent current from VOUT in Burst Mode® operation, accurate power-good and power failure indicators, and thermal overload protection. The LTC3128 is offered in low profile, thermally enhanced 20-Lead 4mm × 5mm × 0.75mm QFN and 24-Lead TSSOP packages.

LT, LT, LTC, LTM, Burst Mode, Linear Technology and the Linear logo are registered trademarks and PowerPath is a trademark of Linear Technology Corporation. All other trademarks are the property of their respective owners.

TYPICAL APPLICATION
Wide VIN (3A Programmed Input Current) to 4.2V

Stacked Output Capacitors Charging Waveform
# LTC3128

## Absolute Maximum Ratings

(Nota 1)

- $V_{IN}$, RSEN, $V_{OUTP}$, MID Voltage: $-0.3$V to 6V
- RSENS, $V_{OUTS}$ Voltage: $-0.3$V to 6V
- RSENS DC Current: $-4$A
- SW1, SW2 DC Voltage: $-0.3$V to 6V
- SW1, SW2 Pulsed (<100ns) Voltage: $-1.0$V to 7V
- PGOOD, PFO, RUN Voltage: $-0.3$V to 6V
- PROG, MAXV, FB, PFI Voltage: $-0.3$V to 6V
- PGOOD, PFO DC Current: 15mA

### Operating Junction Temperature Range

(Nota 2, 4)

- $-40°C$ to $125°C$

### Storage Temperature Range

- $-65°C$ to $150°C$

### Lead Temperature (Soldering, 10 sec)

- $300°C$

### Pin Configuration

#### Top View

<table>
<thead>
<tr>
<th>Pin</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>NC</td>
</tr>
<tr>
<td>2</td>
<td>NC</td>
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<tr>
<td>3</td>
<td>NC</td>
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<tr>
<td>4</td>
<td>NC</td>
</tr>
<tr>
<td>5</td>
<td>NC</td>
</tr>
<tr>
<td>6</td>
<td>GND</td>
</tr>
<tr>
<td>7</td>
<td>VIN</td>
</tr>
<tr>
<td>8</td>
<td>SW1</td>
</tr>
<tr>
<td>9</td>
<td>RSENS</td>
</tr>
<tr>
<td>10</td>
<td>RUN</td>
</tr>
<tr>
<td>11</td>
<td>PROG</td>
</tr>
<tr>
<td>12</td>
<td>SW2</td>
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<tr>
<td>13</td>
<td>RSEN</td>
</tr>
<tr>
<td>14</td>
<td>SW1</td>
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<tr>
<td>15</td>
<td>RSENS</td>
</tr>
<tr>
<td>16</td>
<td>SW2</td>
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<tr>
<td>20</td>
<td>NC</td>
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<td>21</td>
<td>SW1</td>
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<td>22</td>
<td>SW1</td>
</tr>
<tr>
<td>23</td>
<td>SW2</td>
</tr>
<tr>
<td>24</td>
<td>SW2</td>
</tr>
<tr>
<td>25</td>
<td>NC</td>
</tr>
</tbody>
</table>

#### UFD Package

- 20-lead (4mm × 5mm) Plastic QFN
- $T_{MAX} = 125°C$, $\theta_{JA} = 43°C/W$
- Exposed pad (Pin 21) is GND, must be soldered to PCB (Nota 5)

#### FE Package

- 24-lead Plastic TSSOP
- $T_{MAX} = 125°C$, $\theta_{JA} = 38°C/W$
- Exposed pad (Pin 25) should be soldered to PCB (Nota 5)

### Order Information

#### Lead Free Finish

- LTC3128EUFD#PBF
- LTC3128EUFD#TRPBF
- 3128
- 20-Lead (4mm × 5mm) Plastic QFN
- $-40°C$ to $125°C$

- LTC3128IUFD#PBF
- LTC3128IUFD#TRPBF
- 3128
- 20-Lead (4mm × 5mm) Plastic QFN
- $-40°C$ to $125°C$

- LTC3128EFE#PBF
- LTC3128EFE#TRPBF
- LTC3128FE
- 24-Lead Plastic TSSOP
- $-40°C$ to $125°C$

- LTC3128IFE#PBF
- LTC3128IFE#TRPBF
- LTC3128FE
- 24-Lead Plastic TSSOP
- $-40°C$ to $125°C$

Consult LTC Marketing for parts specified with wider operating temperature ranges.

Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: [http://www.linear.com/leadfree/](http://www.linear.com/leadfree/)

For more information on tape and reel specifications, go to: [http://www.linear.com/tapeandreel/](http://www.linear.com/tapeandreel/)
## ELECTRICAL CHARACTERISTICS

The ● denotes specifications that apply over the specified operating junction temperature range, otherwise specifications are at $T_A = 25^\circ C$. (Note 2) $V_{IN} = 3.3V$, $V_{OUT} = 4.8V$, unless otherwise noted.

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Operating Range</td>
<td>●</td>
<td>1.73</td>
<td>5.5</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Programmed Output Voltage Range</td>
<td>●</td>
<td>1.8</td>
<td>5.5</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>FB Voltage</td>
<td>●</td>
<td>0.565</td>
<td>0.580</td>
<td>0.590</td>
<td>V</td>
</tr>
<tr>
<td>FB Voltage Hysteresis</td>
<td>●</td>
<td>8.5</td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>FB Input Current</td>
<td>FB &gt; 0.590V</td>
<td>0.5</td>
<td>2</td>
<td></td>
<td>nA</td>
</tr>
<tr>
<td>Switching Frequency</td>
<td>While Charging</td>
<td>1.00</td>
<td>1.20</td>
<td>1.40</td>
<td>MHz</td>
</tr>
<tr>
<td>Power Good Rising Threshold Voltage</td>
<td>Measured as a % of FB Voltage</td>
<td>●</td>
<td>94.50</td>
<td>96.75</td>
<td>99.00</td>
</tr>
<tr>
<td>Power Good Hysteresis</td>
<td>Measured as a % of FB Voltage</td>
<td>●</td>
<td>3.6</td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>Power Good Voltage Low</td>
<td>$I_{PGOOD} = 5mA$</td>
<td>200</td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>Power Good Leakage Current</td>
<td>$PGOOD = 5.5V$</td>
<td>0.1</td>
<td>1</td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>PFI Falling Threshold</td>
<td>●</td>
<td>0.565</td>
<td>0.580</td>
<td>0.590</td>
<td>V</td>
</tr>
<tr>
<td>PFI Hysteresis Current</td>
<td>$V_{PFI} &lt; 0.565V$</td>
<td>0.2</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>PFI Input Current</td>
<td>$V_{PFI} &gt; 0.590V$</td>
<td>0.5</td>
<td>2</td>
<td></td>
<td>nA</td>
</tr>
<tr>
<td>PFI Voltage Low</td>
<td>$I_{PFIO} = 5mA$</td>
<td>200</td>
<td></td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>PFI Leakage Current</td>
<td>$PFI = 5.5V$</td>
<td>0.1</td>
<td>1</td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>Maximum Capacitor Voltage – Rising</td>
<td>$R_{MAXV} = 125k, -40^\circ C to 125^\circ C$ (Note 7)</td>
<td>●</td>
<td>2.350</td>
<td>2.500</td>
<td>2.650</td>
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<tr>
<td></td>
<td>$R_{MAXV} = 125k, 0^\circ C to 85^\circ C$ (Notes 6, 7)</td>
<td>●</td>
<td>2.400</td>
<td>2.500</td>
<td>2.600</td>
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<tr>
<td></td>
<td>$R_{MAXV} = 113k, -40^\circ C to 125^\circ C$ (Note 7)</td>
<td>●</td>
<td>2.150</td>
<td>2.260</td>
<td>2.380</td>
</tr>
<tr>
<td></td>
<td>$R_{MAXV} = 113k, 0^\circ C to 85^\circ C$ (Notes 6, 7)</td>
<td>●</td>
<td>2.170</td>
<td>2.260</td>
<td>2.350</td>
</tr>
<tr>
<td>Maximum Capacitor Voltage Hysteresis</td>
<td>●</td>
<td>120</td>
<td>200</td>
<td></td>
<td>mV</td>
</tr>
<tr>
<td>MAXV Pin Current</td>
<td>●</td>
<td>20</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>$V_{IN}$ Quiescent Current – Sleep</td>
<td>$V_{RUN} = 3.3V, V_{FB} &gt; 0.590V$</td>
<td>14</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>$V_{OUT}$ Quiescent Current – Sleep</td>
<td>$V_{RUN} = 3.3V$, Not Balancing, $V_{FB} &gt; 0.590V$</td>
<td>1.9</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>$V_{IN}$ Quiescent Current – Shutdown</td>
<td>$V_{RUN} = 0V$, Not Including SW Leakage</td>
<td>0.6</td>
<td>1</td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>$V_{OUT}$ Quiescent Current – Shutdown</td>
<td>$V_{RUN} = 0V$, Not Including SW Leakage</td>
<td>0.4</td>
<td>1</td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>$V_{IN}$ Quiescent Current – UVLO</td>
<td>$V_{RUN} = 1.5V$, $V_{IN} = 1.5V$, Not Including SW Leakage</td>
<td>25</td>
<td></td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>$V_{OUT}$ Quiescent Current – UVLO</td>
<td>$V_{RUN} = 1.5V$, $V_{IN} = 1.5V$, Not Including SW Leakage</td>
<td>1</td>
<td>2</td>
<td></td>
<td>µA</td>
</tr>
<tr>
<td>Input Current Limit</td>
<td>$R_{PROG} = 22.1k$ (Notes 3, 7)</td>
<td>489</td>
<td>497</td>
<td>504</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td>$R_{PROG} = 22.1k$ (Notes 3, 7)</td>
<td>475</td>
<td>497</td>
<td>515</td>
<td>mA</td>
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<tr>
<td></td>
<td>$R_{PROG} = 11k$ (Notes 3, 7)</td>
<td>985</td>
<td>1000</td>
<td>1015</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td>$R_{PROG} = 11k$ (Notes 3, 7)</td>
<td>958</td>
<td>1000</td>
<td>1035</td>
<td>mA</td>
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<tr>
<td></td>
<td>$R_{PROG} = 5.49k$ (Notes 3, 7)</td>
<td>1973</td>
<td>2003</td>
<td>2033</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td>$R_{PROG} = 5.49k$ (Notes 3, 7)</td>
<td>1923</td>
<td>2003</td>
<td>2075</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td>$R_{PROG} = 3.57k$ (Notes 3, 7)</td>
<td>3034</td>
<td>3081</td>
<td>3127</td>
<td>mA</td>
</tr>
<tr>
<td></td>
<td>$R_{PROG} = 3.57k$ (Notes 3, 7)</td>
<td>2951</td>
<td>3081</td>
<td>3185</td>
<td>mA</td>
</tr>
</tbody>
</table>
**Note 1.** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2.** The LTC3128 is tested under pulsed load conditions such that T_J = T_A. The LTC3128E is guaranteed to meet specifications from 0°C to 85°C junction temperature. Specifications over the –40°C to 125°C operating junction temperature range are assured by design, characterization and correlation with statistical process controls. The LTC3128I is guaranteed over the full –40°C to 125°C operating junction temperature range. The junction temperature (T_J) is calculated from the ambient temperature (T_A) and power dissipation (P_D) according to the formula: T_J = T_A + (P_D * θ_JA°C/W), where θ_JA is the package thermal impedance. Note that the maximum ambient temperature consistent with these specifications is determined by specific operating conditions in conjunction with board layout, the rated package thermal resistance and other environmental factors.

**Note 3.** Current measurements are made when the output is not switching.

**Note 4.** This IC includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed 125°C when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may result in device degradation or failure.

**Note 5.** Failure to solder the exposed backside of the package to the PC board ground plane will result in a thermal resistance much higher than 43°C/W in the QFN and 38°C/W in the TSSOP.

**Note 6.** Guaranteed by design. Not tested.

**Note 7.** Accuracy of this specification is directly related to the accuracy of the resistor used to program the parameter.
TYPICAL PERFORMANCE CHARACTERISTICS  \( T_A = 25^\circ C, \) unless otherwise noted.

### Maximum Programmable \( I_{\text{IN}} \) vs \( V_{\text{IN}} \)

![Graph](image1)

### \( V_{\text{IN}} \) Quiescent Current vs \( V_{\text{IN}} \) (Burst Mode Operation Sleep)

![Graph](image2)

### \( V_{\text{IN}} \) Quiescent Current vs \( V_{\text{IN}} \) (Input UVLO)

![Graph](image3)

### \( V_{\text{OUT}} \) Quiescent Current vs \( V_{\text{OUT}} \) (Burst Mode Operation Sleep)

![Graph](image4)

### Feedback Voltage vs Temperature (Normalized)

![Graph](image5)

### PFI Voltage vs Temperature (Normalized)

![Graph](image6)

### PGOOD Threshold vs Temperature (Normalized)

![Graph](image7)

### PGOOD Pull Down Resistance vs \( V_{\text{IN}} \)

![Graph](image8)

---

For more information [www.linear.com/LTC3128](http://www.linear.com/LTC3128)
TYPICAL PERFORMANCE CHARACTERISTICS  \( T_A = 25°C \), unless otherwise noted.

**Minimum and Maximum Programmed Capacitor Voltage vs Programmed \( V_{OUT} \)**

**Normalised Maximum Capacitor Voltage (\( \% \))**

**Startup Waveform 1.0A Input Current Limit**

**Startup Waveform 3.0A Input Current Limit**

For more information www.linear.com/LTC3128
PIN FUNCTIONS (QFN/TSSOP)

SW1 (Pins 1, 19/Pins 1, 4): Switch pin where internal switches A and B are connected. Connect an inductor from SW1 to SW2.

RSENP (Pin 2/Pin 5): Sense Resistor Power Output. Connect other loads in the system to this pin. A 10µF or greater ceramic capacitor should be placed as close to RSENP and GND as possible.

RSENS (Pin 3/Pin 6): Sense Resistor Signal Input. This pin should be connected to RSENP through as short and wide a trace as possible.

RUN (Pin 4/Pin 7): Logic-Controlled Shutdown Input.
- RUN ≥ 1.2V: Normal Operation
- RUN ≤ 0.3V: Shutdown

PROG (Pin 5/Pin 8): Sets the average input current limit threshold. Connect a resistor and capacitor from PROG to GND. See below for component value selection.

\[
R_{\text{PROG}} (\text{kΩ}) = \frac{11}{I_{\text{LIMIT}} (\text{A})}
\]
\[
C_{\text{PROG}} (\text{pF}) = \frac{1600}{R_{\text{PROG}} (\text{kΩ})}
\]

NC (Pins 6, 20/Pins 9, 10, 22): Not Connected. These pins should be tied to ground.

VIN (Pin 7/Pin 11): Input Supply Pin. Internal VCC for the IC and high current input to the internal sense resistor. A 10µF or greater ceramic capacitor should be placed as close to VIN and GND as possible.

PFÖ (Pin 8/Pin 13): Power Fail Output. This is an open-drain output that sinks current when the supply being monitored is less than the programmed threshold voltage.

PFI (Pin 9/Pin 14): Power Fail Input. Connect resistor divider tap from supply to be monitored here. See below for component selection.

\[
V_{\text{PFI(FALLING)}} (V) = 0.58 \times (1+R4/R3)
\]
\[
V_{\text{PFIHYST}} (V) = R4 \times 0.2\mu A
\]

MAXV (Pin 10/Pin 15): Sets the maximum capacitor voltage across each capacitor. Connect a resistor from MAXV to GND. See below for component value selection. If charging only a single capacitor, tie this pin to ground.

\[
R_{\text{MAXV}} (\text{kΩ}) = 50 \times V_{\text{MAXV}} (V)
\]

FB (Pin 11/Pin 16): Output Voltage Feedback Pin. Connect resistor divider tap here. The output voltage can be adjusted from 1.8V to 5.5V. The feedback reference voltage is 0.58V.

\[
V_{\text{OUT}} (V) = 0.58 \times (1+R2/R1)
\]

PGOOD (Pin 12/Pin 17): Power Good Indicator. This is an open-drain output that pulls low when VOUT is less than 96.75% of the programmed voltage.

MID (Pin 13/Pin 18): Output for the active charger balancer. This pin should be tied to the junction of the two output capacitors. If charging only a single output capacitor, tie this pin to ground as shown in the applications section.

VOUTS (Pin 14/Pin 19): Output Sense Input. This pin should be connected to the VOUT capacitor through as short a trace as possible.

VOUTP (Pins 15, 16/Pins 20, 21): Output of the Synchronous Rectifier. Connect the output filter capacitor from this pin to GND. See the applications information section for capacitor recommendations.

SW2 (Pins 17, 18/Pins 23, 24): Switch pin where internal switches C and D are connected. Connect inductor from SW1 to SW2.

GND (Exposed Pad Pin 21/Pins 2, 3, 12 Exposed Pad Pin 25): IC and Power Ground. The exposed pad must be soldered to the PCB ground plane through a good electrical and thermal connection.
BLOCK DIAGRAM

For more information www.linear.com/LTC3128
OPERATION

The LTC3128 is an average input current controlled buck-boost DC/DC charger offered in both a thermally enhanced 4mm × 5mm 20-lead QFN package and a thermally enhanced 24-lead TSSOP package. The buck-boost charger utilizes a proprietary switching algorithm which allows its output to be regulated above, below, or equal to the input voltage. The low R_DS(ON), low gate charge synchronous switches provide high efficiency conversion to minimize the charging time of storage elements.

Charger Operation

The LTC3128 uses fixed frequency, average input current PWM control when charging the output capacitor(s). A proprietary switching algorithm allows the charger to switch between buck and boost modes without discontinuity in inductor current or loop characteristics. The switch topology for the buck-boost charger is shown in Figure 1. Two switches (D and E) connect SW2 to VOUT to provide high efficiency over the entire output voltage range. As the input voltage decreases further, switch pair CD is pulse width modulated to obtain the desired output voltage. At this point, the converter is operating solely in boost mode. When VOUT is below 1.5V typical, switch D and E are modulated. This helps to improve efficiency at low VOUT voltages.

This switching algorithm provides a seamless transition between operating modes and eliminates discontinuities in average inductor current, inductor current ripple, and loop transfer function throughout all operational modes. These advantages result in increased efficiency and stability in comparison to the traditional 4-switch buck-boost converter.

Error Amplifier And Compensation

The LTC3128 utilizes two control loops. The hysteretic voltage loop determines whether the output is in regulation or not, and commands the LTC3128 into a low quiescent current sleep state when VOUT reaches its programmed level. The voltage loop is also equipped with a proportional gain control that reduces the charging current as VOUT approaches regulation. This helps prevent chattering into and out of sleep because of the large charging currents and possibly high equivalent series resistance (ESR) capacitors. The current loop is internally compensated and forces the input current to the programmed input current limit. When the LTC3128 is not sleeping or balancing, it operates at a fixed 1.2MHz frequency.

Current Limit Operation

The LTC3128 has three current limit circuits. The primary current limit is an accurate average input current limit circuit that measures the input current drawn from the source by the LTC3128 and the other loads tied to the RSENS pin via an internal 50mΩ sense resistor. The LTC3128, when not sleeping, will always try to limit the input current passing through the sense resistor. Any current drawn externally from RSENS will result in a corresponding decrease in the charging current supplied by the LTC3128. If the load tied to RSENS draws more than the programmed amount, the LTC3128 will reduce the charging current to zero, although it cannot limit the current draw from external sources. The
**OPERATION**

Input current limit is set by placing a resistor, \( R_{\text{PROG}} \), from PROG to GND. This resistor and the \( C_{\text{PROG}} \) capacitor value can be calculated using the following formula:

\[
R_{\text{PROG}} (\text{k}\Omega) = \frac{11}{I_{\text{LIMIT}} (\text{A})} \\
C_{\text{PROG}} (\text{pF}) \approx \frac{1600}{(R_{\text{PROG}} (\text{k}\Omega)}
\]

Where \( I_{\text{LIMIT}} \) is the average input current limit in amps.

A secondary linear current limit, limits the maximum average inductor current to 5.0A typically. If the peak inductor current reaches 6.5A (typical) switches A and C are immediately turned off, and switches B and D are turned on. The linear and peak current limits are fixed and therefore are not affected by the value of \( R_{\text{PROG}} \).

**Zero Current Comparator**

The zero current comparator monitors the inductor current to the output and shuts off all power switches when this current reduces to approximately 30mA. This prevents the inductor current from reversing in polarity, improving efficiency at light loads.

**Shutdown**

Shutdown of the LTC3128 is accomplished by pulling the RUN pin below 0.3V and IC operation is enabled by pulling the RUN pin above 1.2V. Note that RUN can be driven above \( V_{\text{IN}} \) or \( V_{\text{OUT}} \), as long as it is limited to less than the absolute maximum rating.

**Thermal Shutdown**

If the die temperature exceeds 165°C (typical) the LTC3128 will be disabled. All power devices will be turned off and both switch nodes will be pulled low. The LTC3128 will restart (if enabled) when the die temperature drops to approximately 155°C.

**Thermal Regulator**

To help prevent the part from going into thermal shut-down when charging very large capacitors at high current, the LTC3128 is equipped with a thermal regulator. If the die temperature exceeds 135°C (typical) the average current limit is lowered to help reduce the amount of power being dissipated in the package. The current limit will continue to be reduced to approximately 30% of the programmed limit just before thermal shutdown. The current limit will return to its full value when the die temperature drops below 135°C. See the PCB Layout Considerations section in the Applications Information portion of the data sheet for additional thermal considerations.

**Undervoltage Lockout**

If the input supply voltage drops below 1.60V (typical), the LTC3128 will be disabled and all power devices will be turned off. The LTC3128 will resume operation when \( V_{\text{IN}} \) rises above 1.73V.

**Power Failure Indicator**

The LTC3128 includes a power failure indicator comparator. Referring to the Block Diagram, the non-inverting input of the comparator is internally connected to a 0.58V reference and the inverting input is connected to the PFI pin. An external resistive divider can be placed from the supply being monitored to ground to program the threshold voltage. When the voltage at PFI drops below 0.58V, the open-drain N-channel MOSFET on PFO will turn on, pulling the pin low. The N-channel MOSFET is forced off when PFI drops below 0.58V, a hysteresis current of 0.2µA will turn on, sinking current into the PFI pin providing hysteresis. Once the PFI pin rises above 0.58V plus the programmed hysteresis, the open-drain N-channel MOSFET on PFO will turn off. The power failure indicator voltage and hysteresis can be calculated as follows:

\[
V_{\text{PFI}(\text{FALLING})} (\text{V}) = 0.58 \cdot (1 + \frac{R_4}{R_3}) \\
V_{\text{PFIHYST}} (\text{V}) = R_4 \cdot 0.2 \mu\text{A}
\]

**Power-Good Indicator**

The LTC3128 includes a power-good indicator comparator. The non-inverting input of the comparator is connected to the FB pin and the inverting input is internally connected to a 0.56V reference. When the voltage at FB drops below approximately 0.54V, the open-drain N-channel MOSFET on PGOOD will turn on, pulling the pin low. The N-channel MOSFET is forced off when the LTC3128 is in shutdown.
OPERATION

Maximum Capacitor Voltage Comparator

The LTC3128 monitors the voltage across each capacitor of the stacked output capacitors. If a capacitor exceeds the programmed maximum capacitor voltage, the LTC3128 will stop charging the output stack and begin balancing the voltage on the two capacitors. If the capacitors cannot be balanced and the fault condition still persists, charging will be halted until the output capacitors self discharge so that a fault condition no longer exists. This condition can exist if there is a shorted or damaged output capacitor. The maximum capacitor voltage is programmed by placing a single resistor from MAXV to GND. The $R_{\text{MAXV}}$ resistor should be placed close to the MAXV pin to minimize the pin capacitance. The typical resistor value can be calculated using the following formula:

$$R_{\text{MAXV}} \text{ (k}\Omega\text{)} = 50 \cdot V_{\text{MAXV}} \text{ (V)}$$

Where $V_{\text{MAXV}}$ is the maximum allowable voltage across a capacitor. With the calculated $R_{\text{MAXV}}$ value, the observed $V_{\text{MAXV}}$ can vary as much as ±6%. The maximum capacitor voltage comparator is not enabled until $V_{\text{OUT}}$ is greater than approximately 1.5V. If the MAXV pin is tied to ground, both the maximum capacitor voltage comparator and the active charge balancer are disabled. The MAXV pin should be tied to ground if only a single output capacitor is being charged and no balancing is required. When using a single capacitor, the maximum capacitor voltage is programmed using the FB pin. The voltage loop will prevent overvoltage of the output capacitor, and the MID pin should be grounded. Please refer to the Typical Applications section for an example.

Active Charge Balancer

The LTC3128 includes an active charge balancer for the stacked output capacitors. The balancer efficiently moves charge from the overcharged capacitor to the undercharged capacitor until the two capacitors are determined to be balanced. This helps to ensure the long term reliability of the capacitors by insuring one-half of the programmed output voltage is across each capacitor and eliminates the need for lossy balancing resistors or shunt regulators.

The active charge balancer is enabled once the voltage on the MID pin exceeds approximately 1.2V. The LTC3128 will try to balance the stack only if $V_{\text{OUT}}$ has reached regulation, or if one of the capacitor voltages has exceeded the maximum programmed value. This ensures that the output stack is charged as quickly as possible while protecting each capacitor from being overcharged. The balancer is hysteresis and is enabled once the two capacitors are 60mV out of balance. Once the balancer has equalized the voltage across each capacitor, it is disabled.

The active charge balancer operates by using the inductor connected between SW1 and SW2 to efficiently move charge between the two output capacitors. The charge is moved through a switch that connects the MID pin to SW1 internally. Connecting the MID pin to SW1 allows the LTC3128 to either boost charge from the bottom capacitor to the top, or buck charge from the top capacitor by modulating switches C and D.

If $V_{\text{MID}}$ is 60mV greater than $V_{\text{OUT}} - V_{\text{MID}}$, switches C and F are turned on until the inductor current reaches 400mA. Switch C is then turned off and switch D is turned on until the inductor current reaches 50mA. The switching cycle continues until $V_{\text{MID}} = V_{\text{OUT}} - V_{\text{MID}}$.

If $V_{\text{OUT}} - V_{\text{MID}}$ is 60mV greater than $V_{\text{MID}}$, switches D and F are turned on until the inductor current reaches −400mA. Switch D is then turned off and switch C is turned on until the inductor current reaches −50mA. The switching cycle continues until $V_{\text{MID}} = V_{\text{OUT}} - V_{\text{MID}}$.

The frequency that the balancer will operate at is dependent on the inductor value ($L$) and can be calculated by:

$$f_{\text{balancer}} \text{ (MHz)} \approx \frac{V_{\text{OUT}}}{1.6 \cdot L \text{ (}\mu\text{H)}}$$
APPLICATIONS INFORMATION

A typical LTC3128 application circuit is shown on the front page of this data sheet. The external component selection is determined by the desired output voltage, input current limit, maximum capacitor voltage, and \( V_{\text{OUT}} \) ripple requirements for each particular application. However, basic guidelines and considerations for the design process are provided in this section.

Output Voltage Programming

The output voltage is set by a resistive divider according to the formula:

\[
V_{\text{OUT}} (\text{V}) = 0.58V \times (1 + \frac{R_2}{R_1})
\]

The external divider is connected to the output as shown in Figure 2. The LTC3128 buck-boost charger utilizes input current mode control, and the output divider resistance does not play a role in system stability. Large resistor values can be used to minimize output leakage. The programmed maximum capacitor voltage affects the maximum output voltage that can be programmed. This maximum programmed output voltage can be calculated by:

\[
V_{\text{OUT(MAX)}} = 2 \times (V_{\text{MAXV}} - 440\text{mV}) \quad (\text{–40°C to 125°C})
\]

\[
V_{\text{OUT(MAX)}} = 2 \times (V_{\text{MAXV}} - 385\text{mV}) \quad (0°C \text{ to } 85°C)
\]

Figure 2. Setting the Buck-Boost Output Voltage

Inductor Selection

To achieve high efficiency, a low DCR inductor should be utilized for the buck-boost charger. The inductor must have a saturation rating greater than the worst case average inductor current plus half the ripple current. This is due to the fact that during start-up or high step down ratios, the inductor current will be at the linear current limit (4.0A minimum) even if the programmed input current is less. The peak-to-peak inductor current ripple for buck and boost mode can be calculated from the following formulas, where \( L \) is the inductance in micro Henries:

\[
\Delta I_{L,P-\text{P, BUCK}} (\text{A}) = \frac{V_{\text{OUT}} (V_{\text{IN}} - V_{\text{OUT}})}{V_{\text{IN}} \times L \times 1.2}
\]

\[
\Delta I_{L,P-\text{P,BOOST}} (\text{A}) = \frac{V_{\text{IN}} (V_{\text{OUT}} - V_{\text{IN}})}{V_{\text{OUT}} \times L \times 1.2}
\]

The 1.2MHz switching frequency allows the LTC3128 to utilize small surface mount inductors. Inductor values between 2.2µH and 4.7µH are recommended. These values provide low ripple in the inductor current, but will not adversely affect the stability of the LTC3128. An inductor value that is too small or large will limit the stable input voltage range for a given \( V_{\text{OUT}} \).

High frequency ferrite core inductor materials reduce frequency dependent power losses compared to cheaper powdered iron types, improving efficiency. The inductor should have low DC resistance (approximately 20mΩ or less) to reduce the \( I^2R \) power losses, and must be able to support the peak inductor current without saturating. Molded chokes and chip inductors usually do not have enough core area to support the maximum peak inductor currents of up to 9.0A seen on the LTC3128. The inductor current can still reach currents greater than 5A even at low programmed input currents due to high voltage step-down ratios at start-up. See Table 1 and the reference schematics for suggested components and suppliers.

Input Capacitor Selection

The style and value of capacitors used with the LTC3128 determine input voltage ripple. It is required that a low equivalent series resistance (ESR) multilayer ceramic capacitor of at least 10µF be used to bypass the \( V_{\text{IN}}, \ R_{\text{SENS}} \) and \( R_{\text{SENP}} \) pins.

The value of the capacitor on \( V_{\text{IN}} \) directly controls the amount of input ripple for a given input current pulse, such as during a bucking switching cycle. Increasing the value of this capacitor will reduce the input ripple.
Multilayer ceramic chip capacitors (MLCC) typically have exceptional ESR performance. MLCCs combined with a tight board layout and an unbroken ground plane will yield very good performance and low EMI emissions. There are several types of ceramic capacitors available, each having considerably different characteristics. For example, X7R and X7S ceramic capacitors have the best voltage and temperature stability. X5R ceramic capacitors have higher packing density but poorer performance over their rated voltage and temperature ranges. Y5V ceramic capacitors are not recommended because of their extreme non-linear characteristic of capacitance versus voltage and poor temperature stability.

**OUTPUT CAPACITOR SELECTION**

The LTC3128 is designed to charge supercapacitors with a minimum total output capacitance value greater than 2mF. In general, lower capacitance capacitors have higher ESRs. To prevent modulation in and out of sleep due to the voltage step caused by capacitor ESR, the LTC3128 reduces charge current in the last 5% of the V\textsubscript{OUT} charge cycle. At the end of the charging cycle immediately before sleep, the input current is reduced to 20% of the programmed value. Also of importance is to try and minimize the droop due to the ESR, and keep the droop less than 1% of the programmed output voltage. When the charging current is reduced to zero, the output voltage ESR component is eliminated. The maximum recommended ESR for the recommended 1% droop on V\textsubscript{OUT} is calculated by:

\[
(R\text{ESR}_1 + R\text{ESR}_2)(\Omega) \approx \frac{V\text{OUT}^2}{(20 \cdot V\text{IN} \cdot I\text{LIM} \cdot \eta)}
\]

Where \(R\text{ESR}_1, R\text{ESR}_2\) are the ESR of each capacitor, \(V\text{IN}\) is the input voltage to the charger, \(I\text{LIM}\) is the programmed input current in amps, \(\eta\) is the fractional efficiency of the charger at 20% of the programmed input current, and \(V\text{OUT}\) is the programmed output of the charger. If the ESR of the capacitors is larger than this calculated value, some chattering in and out of sleep at the end of charge may be observed. Figure 3 shows the voltage droop on V\textsubscript{OUT} caused when charging stops.

The LTC3128 is stable with a total output capacitance value greater than 2mF or 4mF for each stacked capacitor. Supercapacitors are much larger physically than ceramic or tantalum capacitors, and therefore usually cannot be placed close to the charger. To minimize layout contribution to capacitor ESR, the trace width connecting the capacitors to each other and the IC should be as large as possible. The MID pin trace is not as critical, as it only carries 200mA.

### Table 1: Recommended Inductors

<table>
<thead>
<tr>
<th>VENDOR</th>
<th>VALUE (µH)</th>
<th>DCR (mΩ)</th>
<th>MAX DC CURRENT (A)</th>
<th>SIZE (mm) W × L × H</th>
</tr>
</thead>
<tbody>
<tr>
<td>Coilcraft</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>XAL5030-222ME</td>
<td>2.2</td>
<td>13.2</td>
<td>9.2</td>
<td>5.0 × 5.0 × 3.0</td>
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<tr>
<td>XAL5030-332ME</td>
<td>3.3</td>
<td>21.2</td>
<td>8.7</td>
<td>5.0 × 5.0 × 3.0</td>
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<tr>
<td>XAL6030-332ME</td>
<td>3.3</td>
<td>19.9</td>
<td>12.2</td>
<td>6.0 × 6.0 × 3.0</td>
</tr>
<tr>
<td>XAL6060-472ME</td>
<td>4.7</td>
<td>13.1</td>
<td>10.5</td>
<td>6.0 × 6.0 × 6.0</td>
</tr>
<tr>
<td>Coiltronics</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>HC8-2R6-R</td>
<td>2.6</td>
<td>11.4</td>
<td>10.2</td>
<td>10.9 × 10.9 × 4.0</td>
</tr>
<tr>
<td>HC8-3R5-R</td>
<td>3.5</td>
<td>16.5</td>
<td>8.5</td>
<td>10.9 × 10.9 × 4.0</td>
</tr>
<tr>
<td>HC7-3R9-R</td>
<td>3.9</td>
<td>7.9</td>
<td>10.4</td>
<td>13.0 × 13.8 × 5.5</td>
</tr>
<tr>
<td>HC7-4R7-R</td>
<td>4.7</td>
<td>9</td>
<td>9.2</td>
<td>13.0 × 13.8 × 5.5</td>
</tr>
<tr>
<td>Sumida</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>CDRH10D68RT125NP-2R2NC</td>
<td>2.2</td>
<td>7.1</td>
<td>10.5</td>
<td>10.2 × 10.2 × 6.8</td>
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<tr>
<td>CDRH10D38DHPNP-3R3PC</td>
<td>3.3</td>
<td>13.5</td>
<td>9.25</td>
<td>10.0 × 10.0 × 3.8</td>
</tr>
<tr>
<td>CDRH127/HPNP-4R7RC</td>
<td>4.7</td>
<td>18.8</td>
<td>10.8</td>
<td>12.5 × 12.5 × 8.0</td>
</tr>
<tr>
<td>TDK</td>
<td></td>
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<td></td>
<td></td>
</tr>
<tr>
<td>VLF12060T-2R7N100</td>
<td>2.7</td>
<td>5.3</td>
<td>10</td>
<td>11.7 × 12.0 × 6.0</td>
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<tr>
<td>VLF12060T-3R9N9R0</td>
<td>3.9</td>
<td>7</td>
<td>9</td>
<td>11.7 × 12.0 × 6.0</td>
</tr>
<tr>
<td>Würth Elektronik</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>744311220</td>
<td>2.2</td>
<td>11.4</td>
<td>9</td>
<td>6.9 × 7.0 × 3.8</td>
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<tr>
<td>744325420</td>
<td>4.2</td>
<td>7.1</td>
<td>11</td>
<td>10.2 × 10.5 × 4.7</td>
</tr>
</tbody>
</table>

For more information [www.linear.com/LTC3128](http://www.linear.com/LTC3128)
APPLICATIONS INFORMATION

Figure 3. VOUT Voltage Droop at End of Charging

of average current during balancing, but the VOUT trace can carry more than 6A of current. It is recommended that local decoupling capacitors be placed from VOUT to MID and from MID to ground, as close to the IC as possible. Multilayer ceramic capacitors are an excellent choice for output decoupling as they have extremely low ESR and are available in small footprints. While a 10μF decoupling capacitor is sufficient for most applications, larger values may be used without limitation.

If using a single output capacitor, where balancing is not required, the MAXV and the MID pin should be tied to ground, this prevents the LTC3128 from trying to balance. The hysteretic voltage loop of the LTC3128 will protect the output capacitor, by regulating it to the voltage programmed by the FB pin.

Pulsed Output Loads

A large output capacitance can be used to help with pulsed load applications by reducing the amount of current required by the LTC3128. The maximum load for a given pulsed load duty cycle and the minimum capacitance can be calculated by:

\[ I_{LOAD(MAX)}(A) = \frac{V_{IN} \cdot I_{LIM} \cdot \eta}{D \cdot V_{OUT}} \]

\[ C_{OUT(MIN)}(F) = \left( I_{PULSE} - \left( \frac{V_{IN} \cdot I_{LIM} \cdot \eta}{V_{OUT}} - I_{STANDBY} \right) \right) \cdot \frac{D \cdot t}{V_{DROOP}} \]

Where \( I_{STANDBY} \) is the continuous load current on the output in amps, \( I_{PULSE} \) is the pulsed load current in addition to \( I_{STANDBY} \) in amps, \( I_{LIM} \) is the programmed average current in amps, \( \eta \) is the LTC3128 converter efficiency, D is the load pulse's duty cycle, and T is the period of the load pulse in seconds. When selecting output supercapacitors for large pulsed loads, the magnitude and duration of the pulsed current, together with the droop voltage specification, determine the choice of the output capacitor. Both the ESR and the charge stored in the capacitors each cycle contribute to the output voltage droop. The droop due to the pulsed load and ESR is calculated by:

\[ \Delta V_{DROOP,LOAD}(V) = \left( I_{PULSE} - \left( \frac{V_{IN} \cdot I_{LIM} \cdot \eta}{V_{OUT}} - I_{STANDBY} \right) \right) \cdot \frac{D \cdot T}{C_{OUT,TOTAL}(F)} \]

\[ \Delta V_{DROOP,ESR}(V) = \left( I_{PULSE} - \left( \frac{V_{IN} \cdot I_{LIM} \cdot \eta}{V_{OUT}} - I_{STANDBY} \right) \right) \cdot (R_{ESR1} + R_{ESR2}) \]

Where \( I_{STANDBY} \) is the continuous load current on the output in amps, \( I_{PULSE} \) is the pulsed load current in addition to \( I_{STANDBY} \) in amps, \( I_{LIM} \) is the programmed average current in amps, D is the load pulse's duty cycle, and T is the period of the load pulse in seconds.

The total output voltage droop is given by:

\[ \Delta V_{DROOP}(V) = \Delta V_{DROOP,LOAD} + \Delta V_{DROOP,ESR} \]

Low ESR and high capacitance are critical to maintaining low output droop. Table 2 and the Typical Applications schematics show supercapacitors that work well with the LTC3128.
The service lifetime of a supercapacitor is determined by its rated voltage, rated temperature, rated lifetime, actual operating voltage, and operating temperature. To extend the life of a supercapacitor the operating voltage and temperature should be reduced from the maximum ratings. The websites for Illinois Capacitor\(^1\) and Maxwell\(^2\) provide the means to determine their capacitor lifetime. Using the suggested derated voltage for each capacitor will improve lifetime. The LTC3128 will keep each capacitor voltage at V\(_\text{OUT}/2\) once the output has reached regulation. To prevent an overvoltage on one of the output capacitors during charging, the maximum capacitor voltage comparators continuously monitor the output stack. If a capacitor exceeds the programmed maximum capacitor voltage, the LTC3128 immediately stops charging the stack. If a capacitor exceeds its maximum voltage and the MID pin is greater than 1.2V, the LTC3128 will balance the voltage of the capacitors, otherwise the part will halt charging until the maximum capacitor voltage violation clears, typically by an external load or leakage. The LTC3128 will start balancing the stacked output capacitors if the output is in regulation and the two capacitors are more than 60mV out of balance, or any time a maximum voltage event occurs. How well the output capacitors are matched will determine the likelihood of triggering a maximum capacitor voltage fault during charging. The maximum capacitor voltage can only force the LTC3128 to stop charging and, depending on other conditions, attempt to balance the capacitors.


**Note 2:** [http://www.maxwell.com/products/ultracapacitors/docs/APPLICATIONNOTE1012839_1.PDF](http://www.maxwell.com/products/ultracapacitors/docs/APPLICATIONNOTE1012839_1.PDF)

### Table 2: Recommended Supercapacitors and Ultracapacitors

<table>
<thead>
<tr>
<th>VENDOR</th>
<th>VALUE (F)</th>
<th>ESR (mΩ)</th>
<th>VOLTAGE (A)</th>
<th>TEMPERATURE RANGE (°C)</th>
<th>SIZE (mm) W × L × H</th>
</tr>
</thead>
<tbody>
<tr>
<td>Murata Electronics</td>
<td>DMF3R5R5L334M3DTA0</td>
<td>0.33</td>
<td>60</td>
<td>4.2 (5.5 Peak)</td>
<td>–30 to 70</td>
</tr>
<tr>
<td></td>
<td>DMF325R5H474M3DTA0</td>
<td>0.47</td>
<td>40</td>
<td>4.2 (5.5 Peak)</td>
<td>–30 to 70</td>
</tr>
<tr>
<td>Tecate</td>
<td>TPL-10/10X30F</td>
<td>10</td>
<td>85</td>
<td>2.7</td>
<td>–40 to 65</td>
</tr>
<tr>
<td></td>
<td>TPL-25/16X26F</td>
<td>25</td>
<td>42</td>
<td>2.7</td>
<td>–40 to 65</td>
</tr>
<tr>
<td></td>
<td>TPL-100/22X45F</td>
<td>100</td>
<td>15</td>
<td>2.7</td>
<td>–40 to 65</td>
</tr>
<tr>
<td></td>
<td>TPLE-25/16X26F</td>
<td>25</td>
<td>42</td>
<td>2.3</td>
<td>–40 to 65</td>
</tr>
<tr>
<td></td>
<td>TPLE-100/22X45F</td>
<td>100</td>
<td>15</td>
<td>2.3</td>
<td>–40 to 65</td>
</tr>
<tr>
<td></td>
<td>TPLS-400/35X60F</td>
<td>400</td>
<td>12</td>
<td>2.7</td>
<td>–40 to 65</td>
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<tr>
<td>AVX</td>
<td>BZ015A503Z_B</td>
<td>0.05</td>
<td>160</td>
<td>5.5</td>
<td>–20 to 70</td>
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<td>BZ015A104Z_B</td>
<td>0.1</td>
<td>80</td>
<td>5.5</td>
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<td>CAP-XX</td>
<td>HS206F</td>
<td>0.6</td>
<td>70</td>
<td>5.5</td>
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<td></td>
<td>HS230</td>
<td>1.2</td>
<td>50</td>
<td>5.5</td>
<td>–40 to 85</td>
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<tr>
<td>Cooper Bussmann</td>
<td>A163S-2R5475-R</td>
<td>4.7</td>
<td>25</td>
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<td></td>
<td>M1325-2R5905-R</td>
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<td>HV1860-2R7107-R</td>
<td>100</td>
<td>10</td>
<td>2.7</td>
<td>–40 to 65</td>
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<tr>
<td>Illinois Capacitor</td>
<td>506DER2R5SLZ</td>
<td>50</td>
<td>30</td>
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<tr>
<td></td>
<td>357DER2R5SEZ</td>
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<td>12</td>
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<td>Maxwell</td>
<td>BCA0005</td>
<td>5</td>
<td>170</td>
<td>2.7</td>
<td>–40 to 65</td>
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<td>BCA0100T01</td>
<td>100</td>
<td>15</td>
<td>2.7</td>
<td>–40 to 65</td>
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<tr>
<td>Taiyo Yuden</td>
<td>PAS2026FR2R5504</td>
<td>0.5</td>
<td>55</td>
<td>2.5</td>
<td>–25 to 60</td>
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<td>PAS0815LS2R5105</td>
<td>1</td>
<td>70</td>
<td>2.5</td>
<td>–25 to 70</td>
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<td></td>
<td>LIC2540R3R8207</td>
<td>200</td>
<td>50</td>
<td>2.2 to 3.8</td>
<td>–25 to 70</td>
</tr>
</tbody>
</table>
APPLICATIONS INFORMATION

The LTC3128 has minimal current draw from V\text{OUT}, especially when the cells are in balance (typically < 2\mu A). Care should be taken to limit sources of current that may pull V\text{OUT} above it’s programmed regulation value, as there is no way for the LTC3128 to maintain regulation in this situation. If there is potential for external leakage to overvoltage the supercapacitors, measures should be taken to protect them.

PCB Layout Considerations

The LTC3128 switches large currents at high frequencies. Special care should be given to the PCB layout to ensure stable, noise free operation. Due to the high input and output power of the LTC3128 a four layer PCB with significant copper and ground planes is strongly recommended. Otherwise the thermal regulator may start to reduce the programmed input current at a lower ambient temperature, and may not be able to prevent the device from entering thermal shutdown.

The LTC3128 evaluation board shows a recommended layout and part placement. Figures 4 through 9 show the part placements and routing, a LTC3128 evaluation board is available on the Linear Technology website. The layout of the PCB and the amount of copper used directly effects the \( \theta_{JA} \) of the LTC3128. The \( \theta_{JA} \) of the LTC3128 on the evaluation board layout shown is 20°C/W. If thinner copper, less copper area, or fewer vias are used then this number will increase. The following items provide guidelines for layout of the LTC3128:

1. Use solid ground plane under the whole circuit (no other traces underneath)
2. Place all decoupling capacitors close to LTC3128 (that ensures low parasitic inductances)
3. Use 2 to 3 local ground vias next to the GND pad of each decoupling capacitor.
4. Place the maximum number of GND vias under the exposed pad of LTC3128 (for low thermal resistance)
5. Place a local GND via next to each component that is connected to ground.
6. Keep FB and MAXV nodes short (place the voltage divider resistors close to the pins)

The LTC3128 is equipped with a thermal regulator that is designed to help protect the LTC3128 from damage due to overheating. The thermal regulator will try to prevent the die temperature from exceeding 135°C by reducing the input current limit, but if it cannot, the LTC3128 will eventually enter thermal shutdown at 165°C. When the junction temperature of the LTC3128 drops back below 135°C the input current limit will no longer be affected.

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**Figure 4. LTC3128 Evaluation Board Top Side Silkscreen**

**Figure 5. LTC3128 Evaluation Board Top Metal**
TYPICAL APPLICATIONS

USB 3.0 (900mA Programmed Input Current) Powered, 4.8V Backup Supply

For more information www.linear.com/LTC3128
5.0V to 3.3V Converter with Power Ride-Through

This circuit will provide the 3.3V output while supercapacitors are discharging from 5V down to 1.8V. The large delta from 5V down to 1.8V allows 87% of stored energy in the supercapacitors to be utilized.

For more information www.linear.com/LTC3128
TYPICAL APPLICATIONS

Supercapacitor Backup with Secondary Converters (3A Programmed Input Current)

Li-Ion 2.8V TO 4.2V 3.0A

µP

TO MAIN SYSTEM LOADS, 3A MAXIMUM

3.3µH

SW1 RSEN PFI PGOOD

SW2 RSENS VOUT FB PROG

LTC3128 MID VOUTP

VOUT = 4.8V

VOUTS TO LOAD

GND

MAXV

FOR LOAD

10µF 10µF 10µF

301k 470pF 400F

2.0M 499k 3.57k

42k

400F

THIS SUPERCAPACITOR BACKUP CIRCUIT WILL DRAW ONLY THE CURRENT THAT IS LEFT OVER FROM THE 3A OF INPUT CURRENT CONSUMED BY MAIN LOADS IN THE SYSTEM.

For more information www.linear.com/LTC3128
PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.

UFD Package
20-Lead Plastic QFN (4mm × 5mm)
(Reference LTC DWG # 05-08-1711 Rev B)

NOTE:
1. DRAWING PROPOSED TO BE MADE A JEDEC PACKAGE OUTLINE MO-220 VARIATION (WXXX-X).
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

For more information www.linear.com/LTC3128
PACKAGE DESCRIPTION

Please refer to http://www.linear.com/designtools/packaging/ for the most recent package drawings.

FE Package
24-Lead Plastic TSSOP (4.4mm)
(Reference LTC DWG # 05-08-1771 Rev B)
Exposed Pad Variation AA

NOTE:
1. CONTROLLING DIMENSION: MILLIMETERS
2. DIMENSIONS ARE IN MILLIMETERS (INCHES)
3. DRAWING NOT TO SCALE
4. RECOMMENDED MINIMUM PCB METAL SIZE FOR EXPOSED PAD ATTACHMENT
   *DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.150mm (.006") PER SIDE
TYPICAL APPLICATION

Single Output Capacitor Application (1.5A Programmed Input Current)

RELATED PARTS

<table>
<thead>
<tr>
<th>PART NUMBER</th>
<th>DESCRIPTION</th>
<th>COMMENTS</th>
</tr>
</thead>
<tbody>
<tr>
<td>LTC3225/LTC3225-1</td>
<td>150mA Supercapacitor Charger</td>
<td>Low Noise, Constant Frequency Charging of Two Series Supercapacitors. Automatic Cell Balancing Prevents Capacitor Overvoltage During Charging. Programmable Charge Current (Up to 150mA). Selectable 2.4V or 2.65V Regulation per Cell (LTC3225), Selectable 2V or 2.25V Regulation per Cell (LTC3225-1), 2mm × 3mm DFN Package</td>
</tr>
<tr>
<td>LTC3226</td>
<td>2-Cell Supercapacitor Charger with Backup PowerPath™ Controller</td>
<td>1×2× Multimode Charger with Automatic Cell Balancing. Internal 2 A LDO Backup Supply. 16 Lead 3mm × 3mm QFN Package</td>
</tr>
<tr>
<td>LTC3625/LTC3625-1</td>
<td>1A High Efficiency 2-Cell Supercapacitor Charger with Automatic Cell Balancing</td>
<td>High Efficiency Step-Up/Step-Down Charging of Two Series Supercapacitors. Automatic Cell Balancing Prevents Capacitor Overvoltage During Charging. Programmable Charging Current Up to 500mA (Single Inductor), 1A (Dual Inductor). ( V_{IN} = 2.7V ) to 5.5V, Selectable 2.4V/2.65V Regulation per Cell (LTC3625). Selectable 2V/2.25V Regulation per Cell (LTC3625-1), Low No-Load Quiescent Current: 23µA. 12-lead 3mm × 4mm DFN Package</td>
</tr>
<tr>
<td>LTC3606B</td>
<td>800mA I_{OUT}, Synchronous Step-Down DC/DC Converter with Average Input Current Limit</td>
<td>95% Efficiency, ( V_{IN} ): 2.5V to 5.5V, ( V_{OUT \text{MAX}} ) = 0.6V, ( I_{Q} ) = 420µA, ( I_{SD} &lt; 1\mu A ), 3mm × 3mm DFN-8 Package</td>
</tr>
<tr>
<td>LTC4425</td>
<td>Supercapacitor Charger with Current Limited Ideal Diode</td>
<td>Constant-Current/Constant-Voltage Linear Charger for 2-cell Series Supercapacitor Stack. ( V_{IN} ): Li-Ion/Polymer Battery, a USB Port, or a 2.7V to 5.5V Current-Limited Supply. 2A Charge Current, Auto Cell Balancing, 20µA Quiescent Current, Shutdown Current &lt; 2µA. Low Profile 12-Pin 3mm × 3mm DFN or a 12-Lead MSOP Packages</td>
</tr>
<tr>
<td>LTC3127</td>
<td>1A Buck-Boost Converter with Programmable Input Current Limit</td>
<td>96% Efficiency, ±4% Accurate Average Input Current Limit, ( V_{IN} ): 1.8V to 5.5V, ( V_{OUT} = 1.8V ) to 5.25V, ( I_{Q} = 35\mu A ), DFN Package</td>
</tr>
<tr>
<td>LTC3125</td>
<td>1.2A I_{OUT}, 1.6MHz, Synchronous Boost DC/DC Converter With Adjustable Input Current Limit</td>
<td>94% Efficiency, ( V_{IN} ): 1.8V to 5.5V, ( V_{OUT \text{MAX}} = 5.25V ), ( I_{Q} = 15\mu A ), ( I_{SD} &lt; 1\mu A ), 2mm × 3mm DFN-8 Package</td>
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